

**Features**

- Uses CRM(CQ) advanced SkyMOS1 technology
- Extremely low on-resistance  $R_{DS(on)}$
- Excellent  $Q_g \times R_{DS(on)}$  product(FOM)
- Qualified according to JEDEC criteria

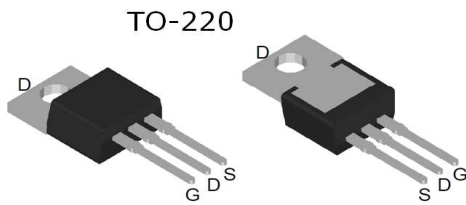
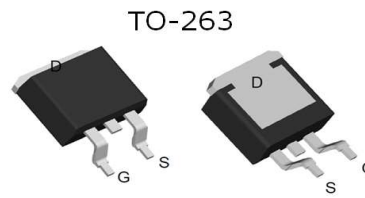
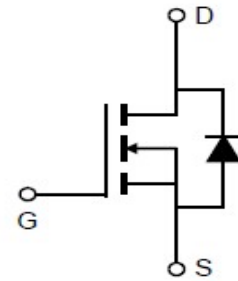
**Applications**

- Synchronous Rectification for AC/DC Quick Charger
- Battery management
- UPS (Uninterruptible Power Supplies)

**Product Summary**

$V_{DS}$	100V
$R_{DS(on)}$	2.5mΩ
$I_D$	180A

**100% DVDS Tested**  
**100% Avalanche Tested**


**CRST030N10N**

**CRSS028N10N**

**Package Marking and Ordering Information**

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRST030N10N	CRST030N10N	TO-220	Tube	N/A	N/A	50pcs
CRSS028N10N	CRSS028N10N	TO-263	Tape	N/A	N/A	1000pcs

**Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Drain-source voltage	$V_{DS}$	100	V
Continuous drain current	$I_D$	207	A
$T_C = 25^\circ\text{C}$ (Silicon limit)		180	
$T_C = 25^\circ\text{C}$ (Package limit)		131	
Pulsed drain current ( $T_C = 25^\circ\text{C}$ , $t_p$ limited by $T_{jmax}$ )	$I_{D\ pulse}$	720	A
Avalanche energy, single pulse ( $L=0.5\text{mH}$ , $R_g=25\Omega$ ) <sup>[1]</sup>	$E_{AS}$	529	mJ
Gate-Source voltage	$V_{GS}$	±20	V
Power dissipation ( $T_C = 25^\circ\text{C}$ )	$P_{tot}$	227	W
Operating junction and storage temperature	$T_j, T_{stg}$	-55...+150	°C

 Notes: 1.EAS was tested at  $T_j = 25^\circ\text{C}$ ,  $I_D = 46\text{A}$ .

**Thermal Resistance**

Parameter	Symbol	Max	Unit
Thermal resistance, junction – case.	$R_{thJC}$	0.55	°C/W
Thermal resistance, junction – ambient(min. footprint)	$R_{thJA}$	62	

**Electrical Characteristic (at  $T_j = 25\text{ °C}$ , unless otherwise specified)**

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		

**Static Characteristic**

Drain-source breakdown voltage	$BV_{DSS}$	100	-	-	V	$V_{GS}=0V, I_D=250\mu A$
Gate threshold voltage	$V_{GS(th)}$	2.2	3	3.8	V	$V_{DS}=V_{GS}, I_D=250\mu A$
Zero gate voltage drain current	$I_{DSS}$	-	0.05	1	$\mu A$	$V_{DS}=100V, V_{GS}=0V$ $T_j=25\text{ °C}$ $T_j=125\text{ °C}$
Gate-source leakage current	$I_{GSS}$	-	$\pm 10$	$\pm 100$	nA	$V_{GS}=\pm 20V, V_{DS}=0V$
Drain-source on-state resistance	$R_{DS(on)}$	-	2.5	3.0	mΩ	$V_{GS}=10V, I_D=90A$ TO-220 TO-263
Transconductance	$g_{fs}$	-	197.2	-	S	$V_{DS}=5V, I_D=90A$

**Dynamic Characteristic**

Input Capacitance	$C_{iss}$	-	11355	-	pF	$V_{GS}=0V, V_{DS}=50V,$ $f=1MHz$
Output Capacitance	$C_{oss}$	-	1446	-		
Reverse Transfer Capacitance	$C_{rss}$	-	54	-		
Gate Total Charge	$Q_G$	-	169	-	nC	$V_{GS}=10V, V_{DS}=50V,$ $I_D=90A$
Gate-Source charge	$Q_{gs}$	-	67	-		
Gate-Drain charge	$Q_{gd}$	-	30	-		
Turn-on delay time	$t_{d(on)}$	-	35	-	ns	$V_{GS}=10V, V_{DD}=50V,$ $R_{G\_ext}=3.0\Omega$
Rise time	$t_r$	-	111	-		
Turn-off delay time	$t_{d(off)}$	-	84	-		
Fall time	$t_f$	-	112	-		
Gate resistance	$R_G$	-	1.8	-	Ω	$V_{GS}=0V, V_{DS}=0V, f=1MHz$

**Body Diode Characteristic**

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Body Diode Forward Voltage	$V_{SD}$	-	0.9	1.4	V	$V_{GS}=0V, I_{SD}=90A$
Body Diode Reverse Recovery Time	$t_{rr}$	-	101	-	ns	$I_F=90A,$ $dI/dt=100A/\mu s;$
Body Diode Reverse Recovery Charge	$Q_{rr}$	-	338	-	nC	

## Typical Performance Characteristics

Fig 1: Output Characteristics

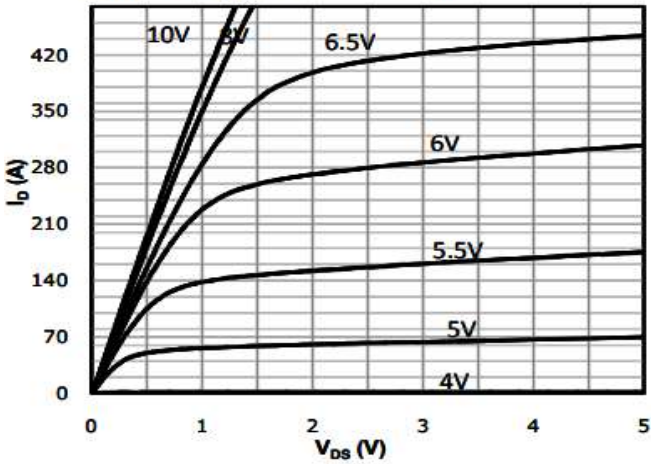
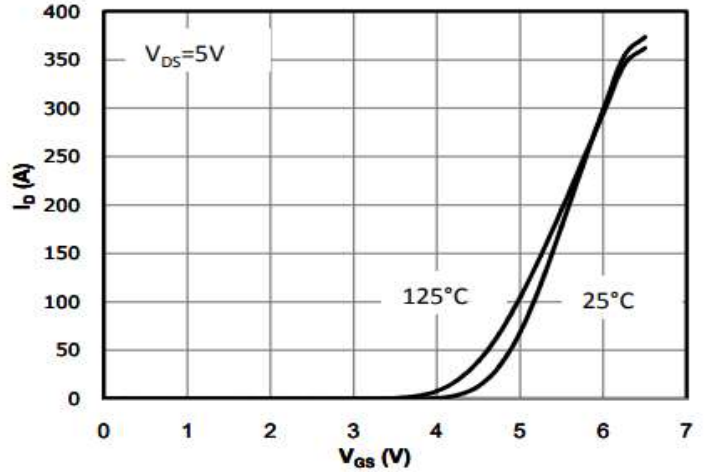


Fig 2: Transfer Characteristics



3: Rds(on) vs Drain Current and Gate Voltage

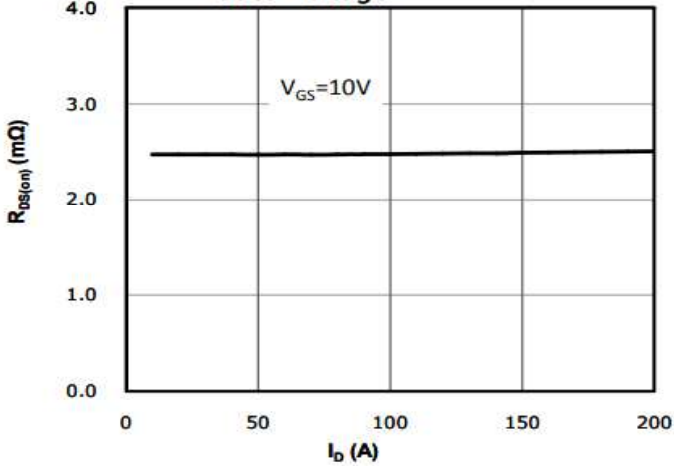


Fig 4: Rds(on) vs Gate Voltage

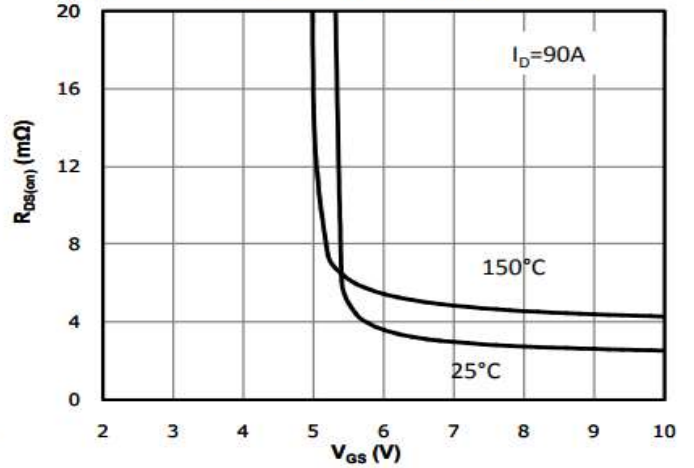


Fig 5: Rds(on) vs. Temperature

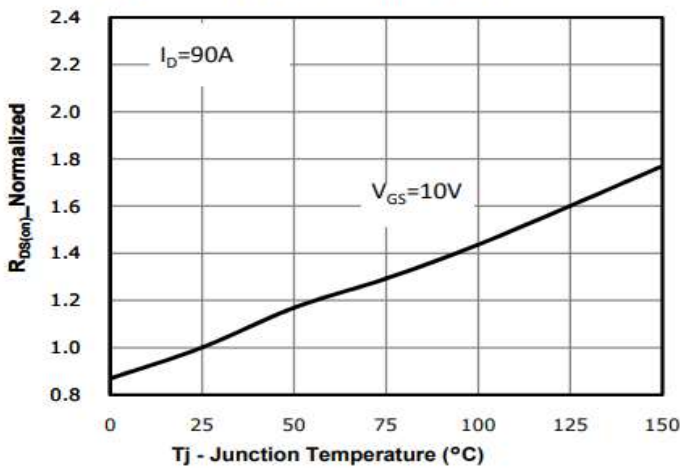


Fig 6: Capacitance Characteristics

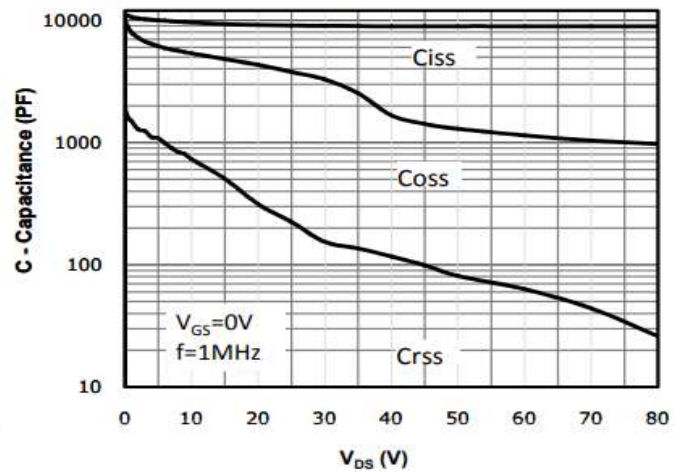


Fig 7: Gate Charge Characteristics

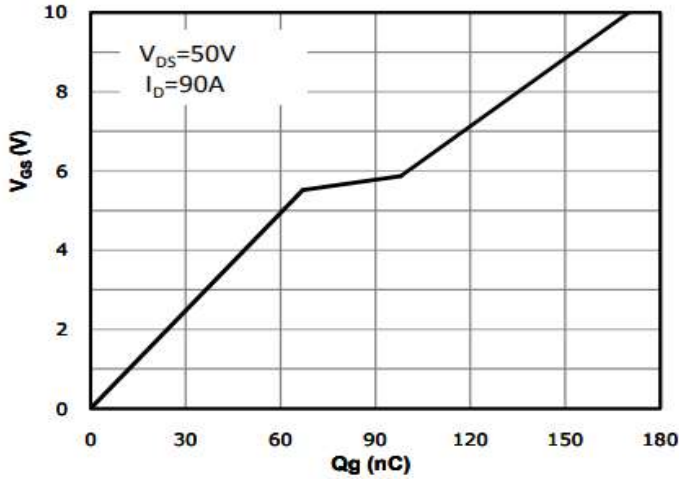


Fig 8: Body-diode Forward Characteristics

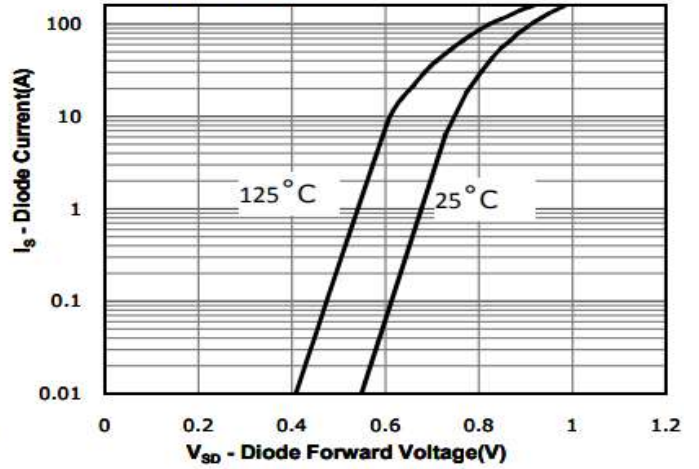


Fig 9: Power Dissipation

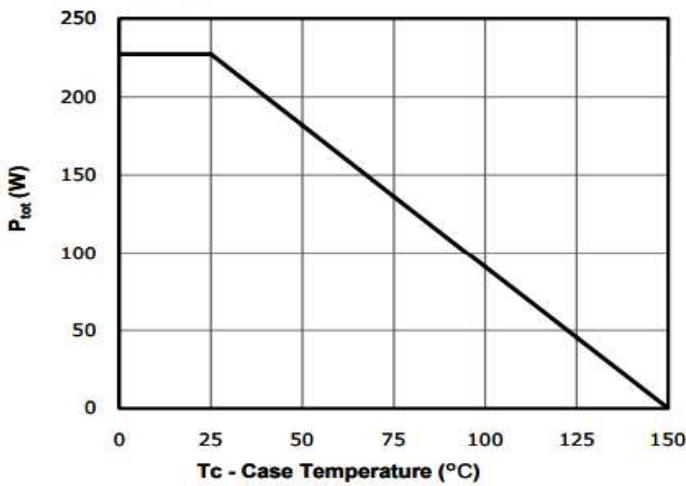


Fig 10: Drain Current Derating

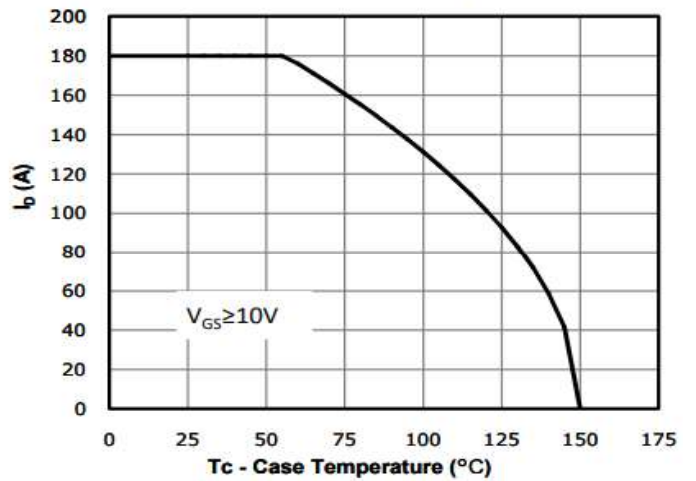


Fig 11: Safe Operating Area

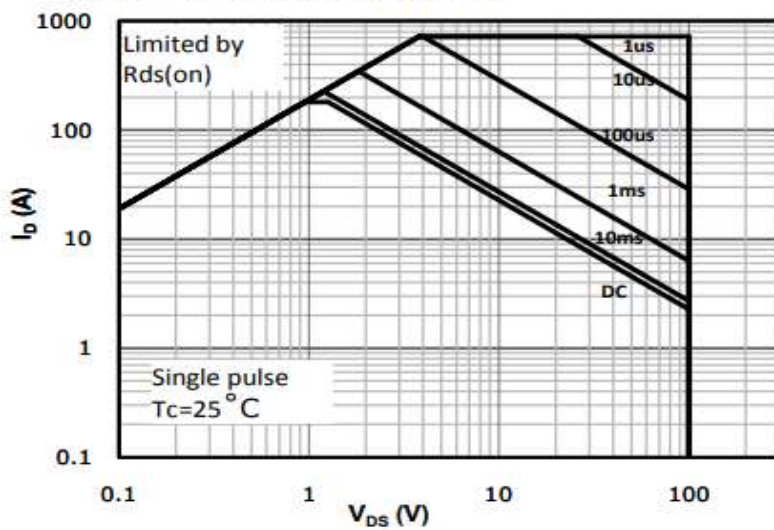
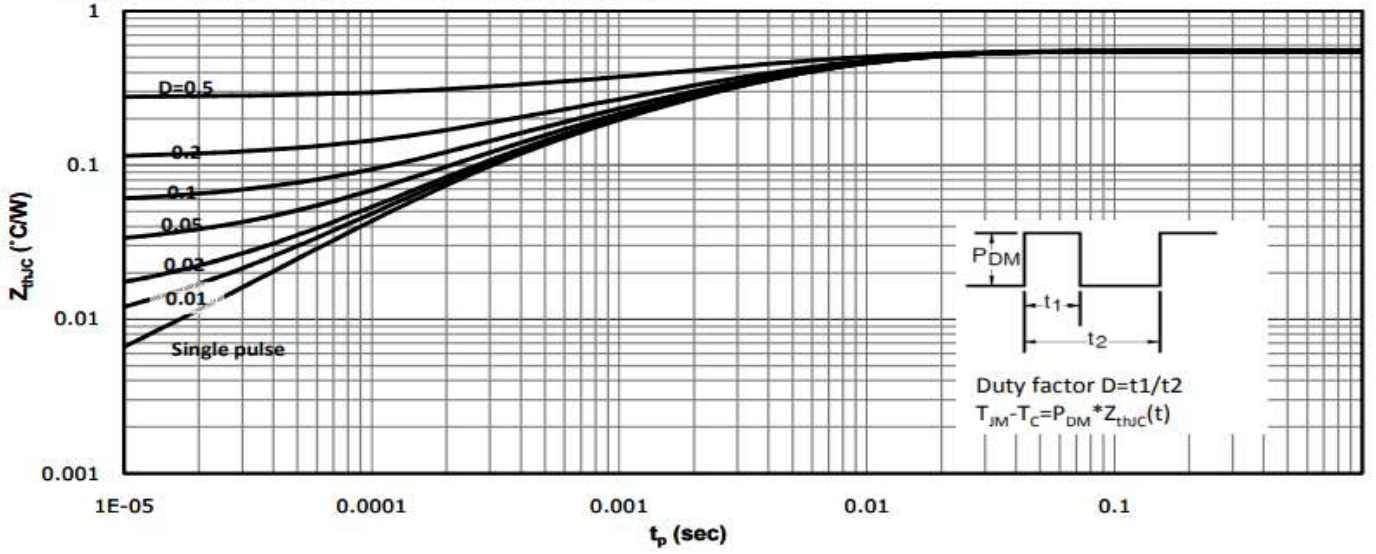
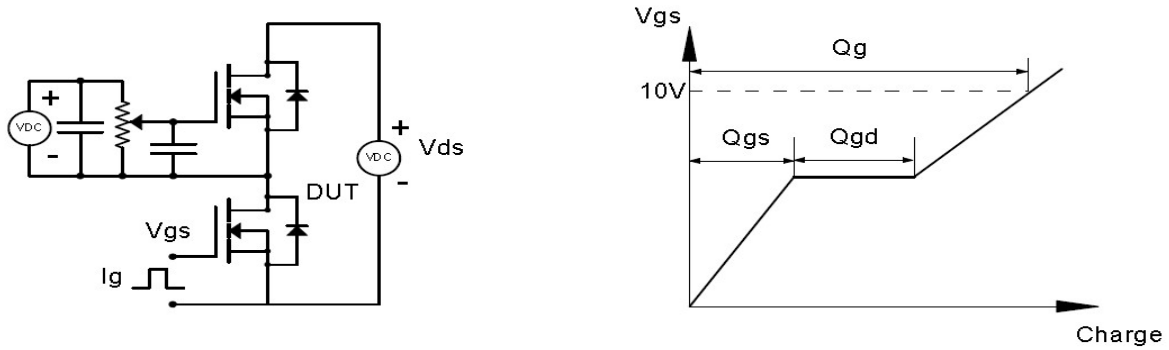


Fig 12: Max. Transient Thermal Impedance

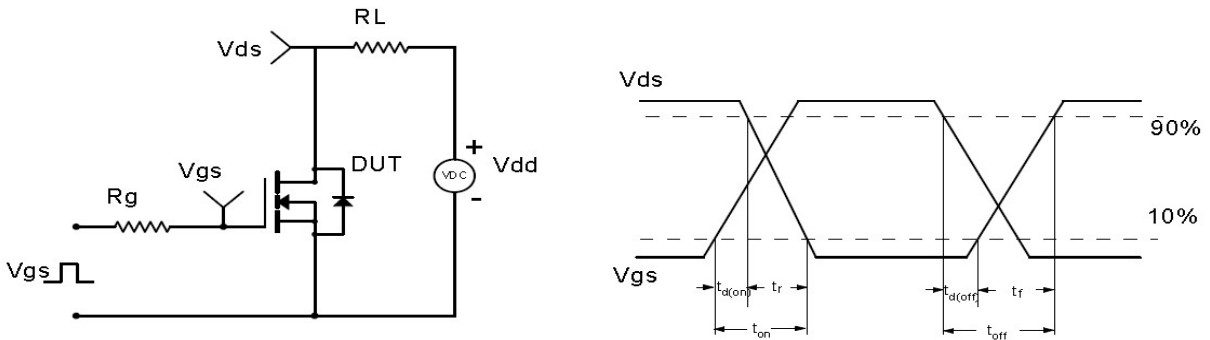


## Test Circuit & Waveform

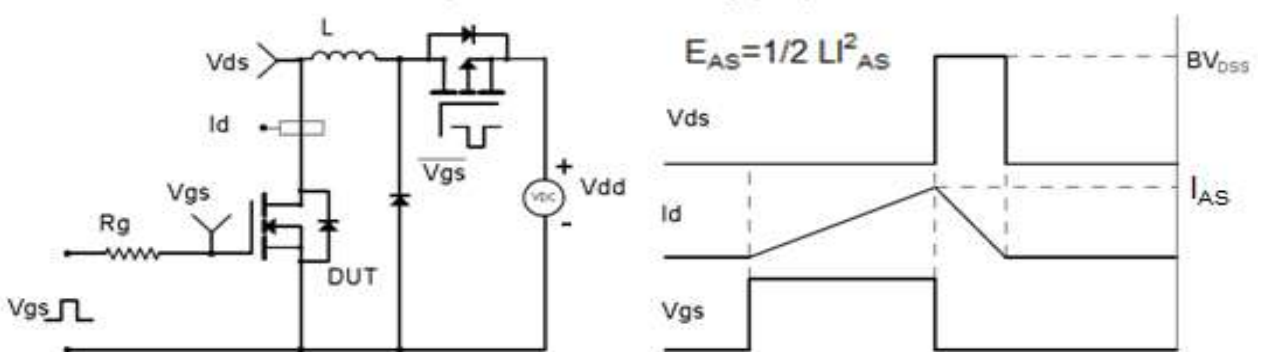
Gate Charge Test Circuit & Waveform



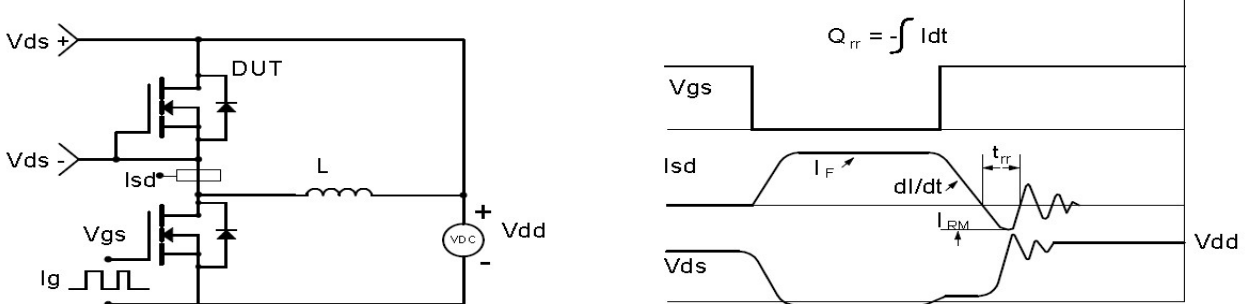
Resistive Switching Test Circuit & Waveforms



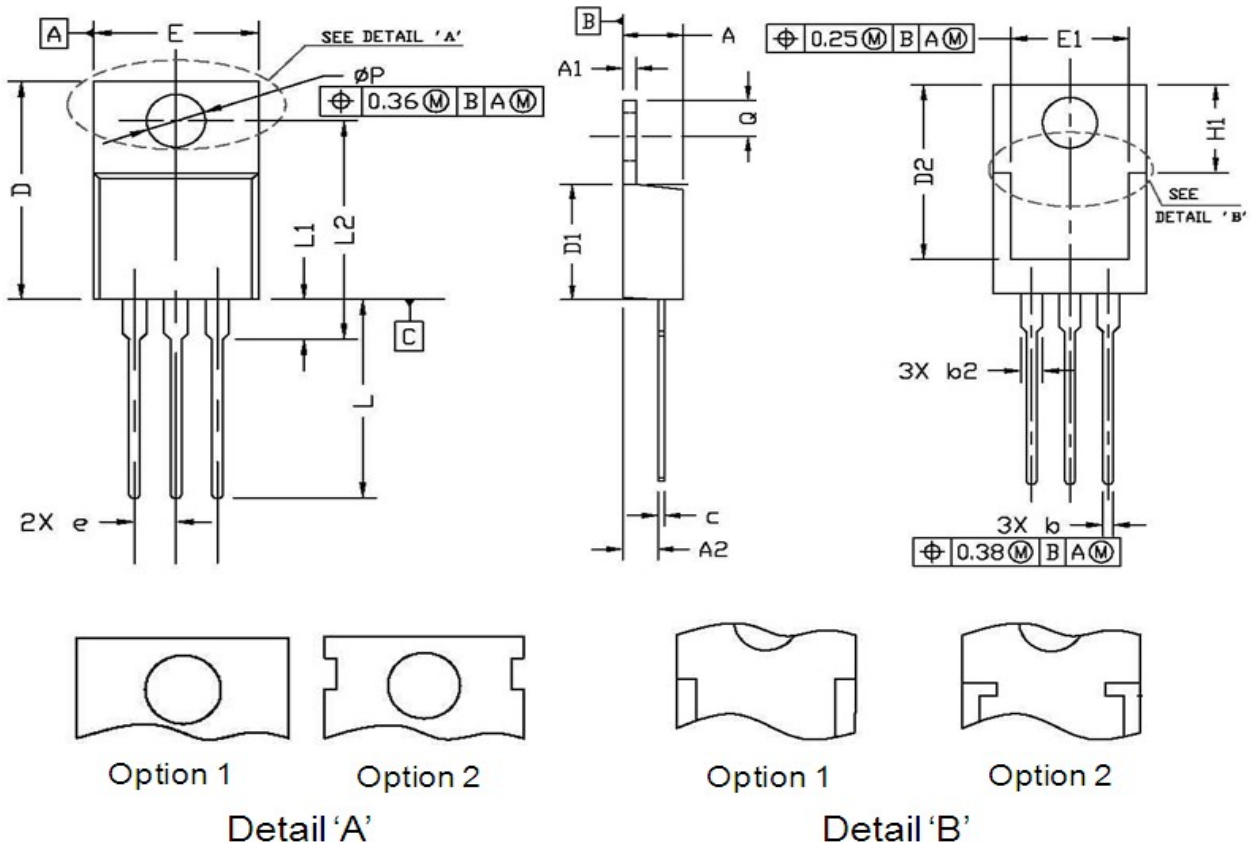
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



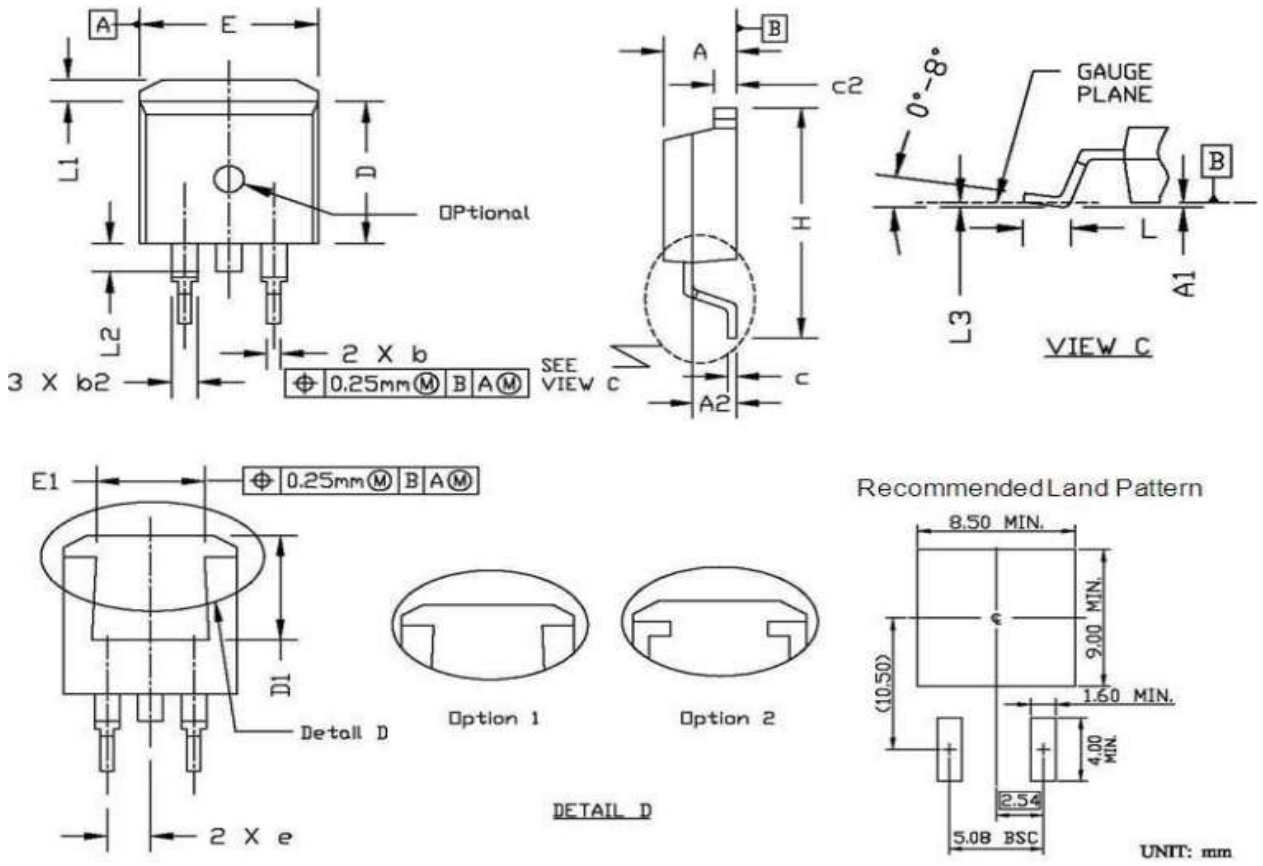
## Package Outline: TO-220-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.30	4.80	0.169	0.189
A1	1.20	1.45	0.047	0.057
A2	2.20	2.90	0.087	0.114
b	0.69	0.95	0.027	0.037
b2	1.00	1.60	0.039	0.063
c	0.33	0.65	0.013	0.026
D	14.70	16.20	0.579	0.638
D1	8.59	9.65	0.338	0.380
D2	11.75	13.60	0.463	0.535
e	2.54 BSC.		0.100 BSC.	
E	9.60	10.60	0.378	0.417
E1	7.00	8.46	0.276	0.333
H1	6.20	7.00	0.244	0.276
L	12.60	14.80	0.496	0.583
L1	2.70	3.80	0.106	0.150
L2	12.13	16.50	0.478	0.650
Q	2.40	3.10	0.094	0.122
P	3.50	3.90	0.138	0.154



## Package Outline: TO-263



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.30	4.86	0.169	0.191
A1	0.00	0.25	0.000	0.010
A2	2.34	2.79	0.092	0.110
b	0.68	0.94	0.027	0.037
b2	1.15	1.35	0.045	0.053
c	0.33	0.65	0.013	0.026
c2	1.17	1.40	0.046	0.055
D	8.38	9.45	0.330	0.372
D1	6.90	8.17	0.272	0.322
e	2.54 BSC.		0.100 BSC.	
E	9.78	10.50	0.385	0.413
E1	6.50	8.60	0.256	0.339
H	14.61	15.88	0.575	0.625
L	2.24	3.00	0.088	0.118
L1	0.70	1.60	0.028	0.063
L2	1.00	1.78	0.039	0.070
L3	0.00	0.25	0.000	0.010

## Revision History

Revision	Date	Major changes
1.0	2018/9/28	Release of formal version.
2.0	2019/1/4	Add TO-263 package type information
3.0	2019/5/28	Supplement package outline info.
4.0	2023/11/20	Package info update.

## Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qualified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.